DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 May 25 2002 Feb 27



BZX79 series

FEATURES

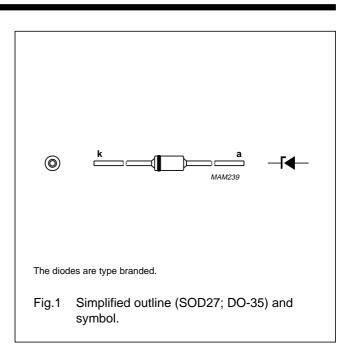
- Total power dissipation: max. 500 mW
- Two tolerance series: ±2%, and approx. ±5%
- Working voltage range: nom. 2.4 to 75 V (E24 range)
- Non-repetitive peak reverse power dissipation: max. 40 W.

APPLICATIONS

• Low voltage stabilizers or voltage references.

DESCRIPTION

Low-power voltage regulator diodes in hermetically sealed leaded glass SOD27 (DO-35) packages. The diodes are available in the normalized E24 \pm 2% (BZX79-B) and approx. \pm 5% (BZX79-C) tolerance range. The series consists of 37 types with nominal working voltages from 2.4 to 75 V.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
l _F	continuous forward current		_	250	mA
I _{ZSM}	non-repetitive peak reverse current	$t_p = 100 \ \mu s$; square wave; T _j = 25 °C prior to surge	see Table	s 1 and 2	А
P _{tot}	total power dissipation	T _{amb} = 50 °C; note 1	_	400	mW
		T _{amb} = 50 °C; note 2	_	500	mW
P _{ZSM}	non-repetitive peak reverse power dissipation	$t_p = 100 \ \mu s$; square wave; $T_j = 25 \ ^\circ C$ prior to surge; see Fig.3	-	40	W
T _{stg}	storage temperature		-65	+200	°C
Tj	junction temperature		-65	+200	°C

Notes

- 1. Device mounted on a printed circuit-board without metallization pad; lead length max.
- 2. Tie-point temperature ≤ 50 °C; max. lead length 8 mm.

ELECTRICAL CHARACTERISTICS

Total BZX79-B and BZX79-C series

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V _F	forward voltage	I _F = 10 mA; see Fig.4	0.9	V

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SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
I _R	reverse current			
	BZX79-B/C2V4	$V_R = 1 V$	50	μA
	BZX79-B/C2V7	$V_R = 1 V$	20	μA
	BZX79-B/C3V0	$V_R = 1 V$	10	μA
	BZX79-B/C3V3	$V_R = 1 V$	5	μA
	BZX79-B/C3V6	V _R = 1 V	5	μA
	BZX79-B/C3V9	$V_R = 1 V$	3	μA
	BZX79-B/C4V3	V _R = 1 V	3	μA
	BZX79-B/C4V7	$V_R = 2 V$	3	μA
	BZX79-B/C5V1	$V_R = 2 V$	2	μA
	BZX79-B/C5V6	V _R = 2 V	1	μA
	BZX79-B/C6V2	$V_R = 4 V$	3	μA
	BZX79-B/C6V8	$V_R = 4 V$	2	μA
	BZX79-B/C7V5	V _R = 5 V	1	μA
	BZX79-B/C8V2	V _R = 5 V	700	nA
	BZX79-B/C9V1	V _R = 6 V	500	nA
	BZX79-B/C10	V _R = 7 V	200	nA
	BZX79-B/C11	V _R = 8 V	100	nA
	BZX79-B/C12	V _R = 8 V	100	nA
	BZX79-B/C13	V _R = 8 V	100	nA
	BZX79-B/C15 to BZX79-B/C75	$V_R = 0.7 V_{Znom}$	50	nA

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	Š	OKNING		Ц	DIFFE		RESIST	ANCE	ΤEP	TEMP. COEFF.		DIODE CAP.	NON-REPETITIVE PEAK
BZX79-		v _z at I _{ztest}	vz (v) at I _{ztest} = 5 mA			r dif (52)	(75		at I _z	s _z (mV/K) at I _{ztest} = 5 mA	mA M	C _d (pF) at f = 1 MHz;	KEVEKSE GURKENI I _{zsm} (A)
BXXX CXXX	Tol. ±	Tol. ±2% (B)	Tol. a ±5%	Tol. approx. ±5% (C)	at I _{ztest}	at I _{Ztest} = 1 mA	at I _{ztest}	at I _{Ztest} = 5 mA	(see	(see Figs 5 and 6)	nd 6)	V _R = 0 V	at t _p = 100 μs; T _{amb} = 25 ∘C
	MIN	MAX.	MIN	MAX.	TYP.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.	MAX.	MAX.
2V4	2.35	2.45	2.2	2.6	275	600	70	100	-3.5	-1.6	0	450	6.0
2V7	2.65	2.75	2.5	2.9	300	600	75	100	-3.5	-2.0	0	450	6.0
3V0	2.94	3.06	2.8	3.2	325	600	80	95	-3.5	-2.1	0	450	6.0
3V3	3.23	3.37	3.1	3.5	350	600	85	95	-3.5	-2.4	0	450	6.0
3V6	3.53	3.67	3.4	3.8	375	600	85	06	-3.5	-2.4	0	450	6.0
3V9	3.82	3.98	3.7	4.1	400	600	85	06	-3.5	-2.5	0	450	6.0
4V3	4.21	4.39	4.0	4.6	410	600	80	06	-3.5	-2.5	0	450	6.0
4V7	4.61	4.79	4.4	5.0	425	500	50	80	-3.5	-1.4	0.2	300	6.0
5V1	5.00	5.20	4.8	5.4	400	480	40	60	-2.7	-0.8	1.2	300	6.0
5V6	5.49	5.71	5.2	6.0	80	400	15	40	-2.0	1.2	2.5	300	6.0
6V2	6.08	6.32	5.8	6.6	40	150	6	10	0.4	2.3	3.7	200	6.0
6V8	6.66	6.94	6.4	7.2	30	80	6	15	1.2	3.0	4.5	200	6.0
7\5	7.35	7.65	7.0	7.9	30	80	6	15	2.5	4.0	5.3	150	4.0
8V2	8.04	8.36	7.7	8.7	40	80	6	15	3.2	4.6	6.2	150	4.0
9V1	8.92	9.28	8.5	9.6	40	100	6	15	3.8	5.5	7.0	150	3.0
10	9.80	10.20	9.4	10.6	50	150	8	20	4.5	6.4	8.0	90	3.0
11	10.80	11.20	10.4	11.6	50	150	10	20	5.4	7.4	9.0	85	2.5
12	11.80	12.20	11.4	12.7	50	150	10	25	6.0	8.4	10.0	85	2.5
13	12.70	13.30	12.4	14.1	50	170	10	30	7.0	9.4	11.0	80	2.5
15	14.70	15.30	13.8	15.6	50	200	10	30	9.2	11.4	13.0	75	2.0
16	15.70	16.30	15.3	17.1	50	200	10	40	10.4	12.4	14.0	75	1.5
18	17.60	18.40	16.8	19.1	50	225	10	45	12.4	14.4	16.0	70	1.5
20	19.60	20.40	18.8	21.2	60	225	15	55	12.3	15.6	18.0	60	1.5
22	21.60	22.40	20.8	23.3	60	250	20	55	14.1	17.6	20.0	60	1.25
24	23.50	24.50	22.8	25.6	60	250	25	70	15.9	19.6	22.0	55	1.25

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Table 1 Per type, BZX79-B/C2V4 to BZX79-B/C24

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	8	ORKING V _z	WORKING VOLTAGE V ₂ (V)	GE	DIFFE	DIFFERENTIAL RESISTANCE r _{dif} (Ω)	RESIST 2)	ANCE	TEN	TEMP. COEFF. S _Z (mV/K)))	DIODE CAP. C _d (pF)	NON-REPETITIVE PEAK REVERSE CURRENT
BZX79-		at I _{ztest}	at I _{Ztest} = 2 mA						atl	at I _{ztest} = 2 mA	mA	at f = 1 MHz;	Izsm (A)
BXXX CXXX	Tol. ±	Tol. ±2% (B)	Tol. a ±5%	Tol. approx. ±5% (C)	at I _{Ztest} :	at I _{Ztest} = 0.5 mA at I _{Ztest} = 2 mA	at I _{Ztest}	= 2 mA	eee)	(see Figs 5 and 6)	nd 6)	V _R = 0 V	at t _p = 100 µs; T _{amb} = 25 °C
	MIN.	MAX.	MIN	MAX.	TYP.	MAX.	TYP.	MAX.	MIN.	TYP.	MAX.	MAX.	MAX.
27	26.50	27.50	25.1	28.9	65	300	25	80	18.0	22.7	25.3	50	1.0
30	29.40	30.60	28.0	32.0	70	300	30	80	20.6	25.7	29.4	50	1.0
33	32.30	33.70	31.0	35.0	75	325	35	80	23.3	28.7	33.4	45	6.0
36	35.30	36.70	34.0	38.0	80	350	35	06	26.0	31.8	37.4	45	0.8
39	38.20	39.80	37.0	41.0	80	350	40	130	28.7	34.8	41.2	45	0.7
43	42.10	43.90	40.0	46.0	85	375	45	150	31.4	38.8	46.6	40	0.6
47	46.10	47.90	44.0	50.0	85	375	50	170	35.0	42.9	51.8	40	0.5
51	50.00	52.00	48.0	54.0	06	400	60	180	38.6	46.9	57.2	40	0.4
56	54.90	57.10	52.0	60.0	100	425	70	200	42.2	52.0	63.8	40	0.3
62	60.80	63.20	58.0	66.0	120	450	80	215	58.8	64.4	71.6	35	0.3
68	66.60	69.40	64.0	72.0	150	475	06	240	65.6	71.7	79.8	35	0.25
75	73.50	76.50	70.0	79.0	170	500	95	255	73.4	80.2	88.6	35	0.2

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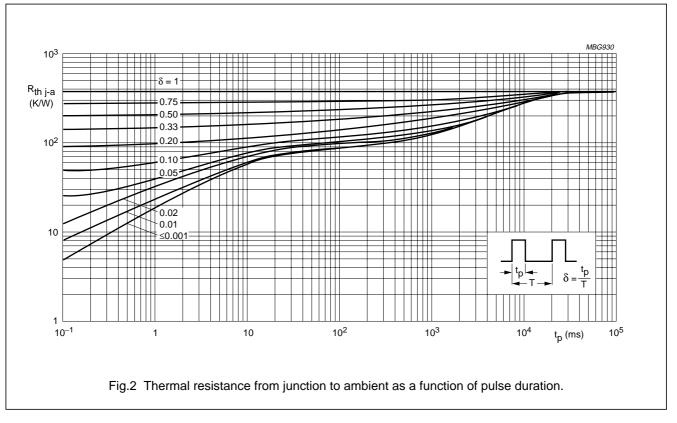
THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point	lead length 8 mm.	300	K/W
R _{th j-a}	thermal resistance from junction to ambient	lead length max.; see Fig.2 and note 1	380	K/W

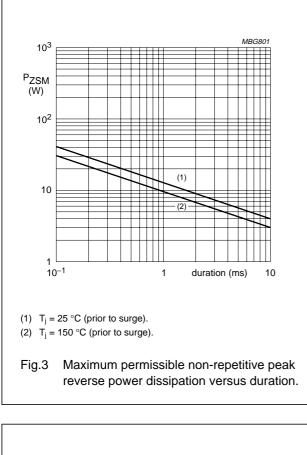
Note

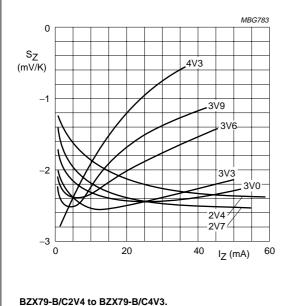
1. Device mounted on a printed circuit-board without metallization pad.

GRAPHICAL DATA



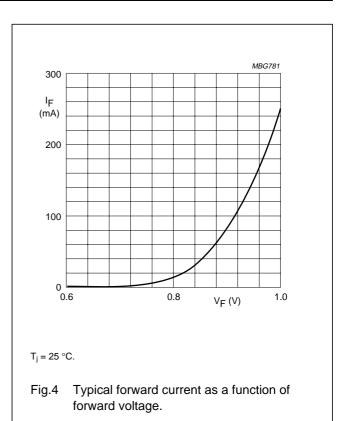
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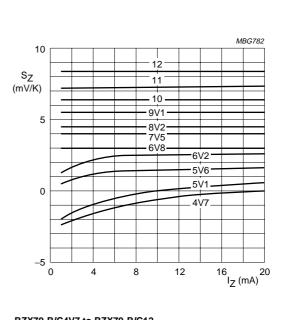




 $T_i = 25$ to 150 °C.

Fig.5 Temperature coefficient as a function of working current; typical values.



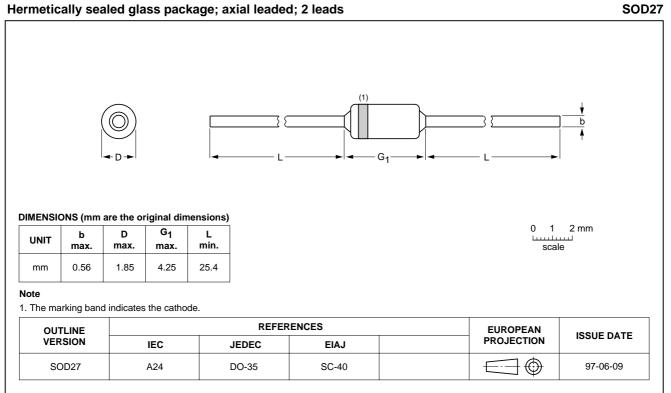


BZX79-B/C4V7 to BZX79-B/C12. $T_j = 25$ to 150 °C.

Fig.6 Temperature coefficient as a function of working current; typical values.

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PACKAGE OUTLINE



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